



Panchip Microelectronics Co., Ltd.

## **PAN1020**

### **Datasheet**

### **BLE SoC Transceiver**

Version: 1.4

Release date: Aug. 2019

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## REVISION HISTORY

| Version | Date      | Content   | Reference                    |
|---------|-----------|---|------------------------------|
| 1.0     | Nov.2017  | Initial   | 《PAN163CX Datasheet_V1.2-EN》 |
| 1.1     | Jul. 2018 | Add the pin description of QFN 48-PIN<br><br>Complement the pakage dimension of the QFN 48-PIN  |                              |
| 1.2     | Dec.2018  | Refresh parts of the parameter of "ELECTRICAL CHARACTERISTICS"<br><br>Modify the description of "Feature"<br><br>Add the chapter of "PRECAUTIONS", "STORAGE CONDITIONS" and "CONTACT US". |                              |
| 1.3     | June.2019 | Add the SSOP24 package.   |                              |
| 1.4     | Aug.2019  | High temperature version  |                              |

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## Abbreviation

|      |                               |       |  |
|------|-------------------------------|-------|--|
| ADC  | Analog-to-Digital Converter   | L2CAP | Logical Link Control and Adaptation Protocol |
| ATT  | Attribute Protocol            | LDO   | Low dropout regulator                        |
| BER  | Bit Error Rate                | LIRC  | Low speed RC oscillator                      |
| BLE  | Bluetooth Low Energy          | LVR   | Low Voltage Reset                            |
| BOD  | Brown-out Detector            | LXT   | Low speed crystal oscillator                 |
| CPU  | Central Processing Unit       | MCU   | Microcontroller Unit                         |
| DMA  | Direct Memory Access          | PLL   | Phase Locked Loop                            |
| FIFO | First Input First Output      | PWM   | Pulse Width Modulation                       |
| GAP  | Generic Access Profile        | RAM   | Random access memory                         |
| GATT | Generic Attribute Profile     | SM    | Security Manager                             |
| GPIO | General-purpose I/O           | SPI   | Serial Peripheral Interface                  |
| HID  | Human Interface Device        | SRAM  | Static Random-Access Memory                  |
| HXT  | High speed crystal oscillator | SWD   | Serial Wire Debug                            |
| I2C  | Inter—Integrated Circuit      | UART  | Universal Asynchronous Receiver/Transmitters |
| IAP  | In-Application-Programming    | WDT   | Watchdog Timer                               |
| ICP  | In-Circuit Programming        | WWDT  | Window Watchdog Timer                        |
| ISP  | In-System Programming         |       |  |

# 1 General Description

The PAN1020 integrated circuit has a fully integrated radio transceiver and baseband processor for Bluetooth Low Energy. It can be used as an application processor as well as a data pump in fully hosted systems.

The PAN1020 contains an embedded Flash memory for storing Bluetooth profiles as well as custom application code. The qualified BLE protocol stack, stored in a dedicated Flash area, as well as the customer application software run on the embedded MCU processor. Low leakage Retention RAM is used to store all the sensitive data and connection information while in Deep Sleep mode.

The BLE firmware includes the L2CAP service layer protocols, Security Manager (SM), Attribute Protocol (ATT), the Generic Attribute Profile (GATT) and the Generic Access Profile (GAP). Furthermore, application profiles such as Proximity, Health Thermometer, Heart Rate, Blood Pressure, Glucose and Human Interface Device (HID) are supported.

The MCU part of PAN1020 is the 32-bit microcontroller. It supports a wide range of applications from low-end, price sensitive designs to computing-intensive ones and provides advanced high-end features in economical products.

The PAN1020 has many high-performance peripheral functions, such as general purpose I/O port(25 GPIOs for QFN32 package, 41 GPIOs for QFN48 package and 15 GPIOs for SSOP24 package), three 32-bit timers, two UARTs, two group SPI interfaces, two I2C interfaces, one 16-bit PWM generators providing eight channels, an 8-channel 12-bit ADC, Watchdog Timer, Window Watchdog Timer, and a Brown-out Detector. All these peripherals have been incorporated into the PAN1020 to reduce component count, board space and system cost.

Additionally, the PAN1020 is equipped with ISP (In-System Programming) and ICP (In-Circuit Programming) functions, which allow the user to update the program memory without removing the chip from the actual end product. PAN1020 also supports In-Application-Programming (IAP) function, user switches the code executing without the chip reset after the embedded flash updated.

The PAN1020 can run up to 52 MHz and operate at a wide voltage range of 2.2V ~ 3.6V and temperature range of -40°C ~ +125°C. For PAN1020, the embedded FLASH size up to 256 Kbytes and SRAM up to 16 Kbytes. It also offers size configurable Data Flash (shared with program flash), and configurable flash size for the ISP.

## 1.1 Key Features

- **RF**

- 2.4GHz RF transceiver(Compatible with BLE4.2)
- RX sensitivity: -90 dBm@1Mbps
- Maximum received signal: 0 dBm
- Programmable TX output power: 13 dBm(Maximum), 8 dBm(Typical)
- Single wire antenna: no RF matching or RX/TX switching required

- **Core**

- MCU core running up to 52 MHz
- One 24-bit system timer



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- Supports low power Idle mode
- A single-cycle 32-bit hardware multiplier
- Supports Serial Wire Debug (SWD) interface and two watchpoints/four breakpoints

- **Memory**

- 256 KB Flash memory for program memory
- 16 KB SRAM

- **Peripheral**

- QFN32 package
  - 25 GPIOs
  - Two UARTs
  - Three SPIs
  - Two I2Cs
  - One 8-channel ADC
  - One 8-channel PWM0
- QFN48 package
  - 41 GPIOs
  - Two UARTs
  - Three SPIs
  - Two I2Cs
  - One 8-channel ADC
  - One 8-channel PWM0
- SSOP24 package
  - 15 GPIOs
  - Two UARTs
  - Three SPIs
  - Two I2Cs
  - One 4-channel ADC
  - One 4-channel PWM0
- Three channel 32-bit Timers (one 8-bit pre-scaler counter with 24-bit up-timer for each timer)
- DMA up to 3 channels (one per source and destination pair)
- Two UART devices with DMA
- Two Group SPI master and slave devices with DMA
- Two I2C master and slaver devices with DMA
- Up to 40 general-purpose I/O (GPIO) pins
- 12-Bit ADC with Eight Channels
- One built-in 16-bit PWM generators with eight channels
- One WDT with 18-bit up counter
- One WWDT with 6-bit down counter value (CNTDAT) and 6-bit compare value (CMP-DAT)

- **Special features**

- ISP (In-System Programming), ICP (In-Circuit Programming), and IAP (In Application Programming)



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- BOD (Brown-out Detector) threshold levels: 2.87V/2.72V/2.34V/2.06V
- 96-bit unique ID
- LVR (Low Voltage Reset) threshold voltage level:  $1.7 \pm 0.1\text{V}$

- **Package**

- QFN32 package,  $5 \times 5$  mm
- QFN48 package,  $6 \times 6$  mm
- SSOP24 package, pin pitch = 0.635mm

- **DC/AC Characteristics**

- Operating Temperature:  $-40^\circ\text{C} \sim 125^\circ\text{C}$
- Operating voltage: 2.2~3.6V
- Reliability: ESD HBM pass  $\pm 2\text{KV}$
- Built-in LDO for wide operating voltage: 2.2V to 3.6V
  - $\sim 2\mu\text{A}$  @ deep sleep mode, wake up by internal 32K oscillator

### 1.2 Typical Applications

- TV and STB remote control
- Wireless mouse and keyboard
- Wireless gamepads
- Smart home automation

## 2 Block Diagram

PAN1020

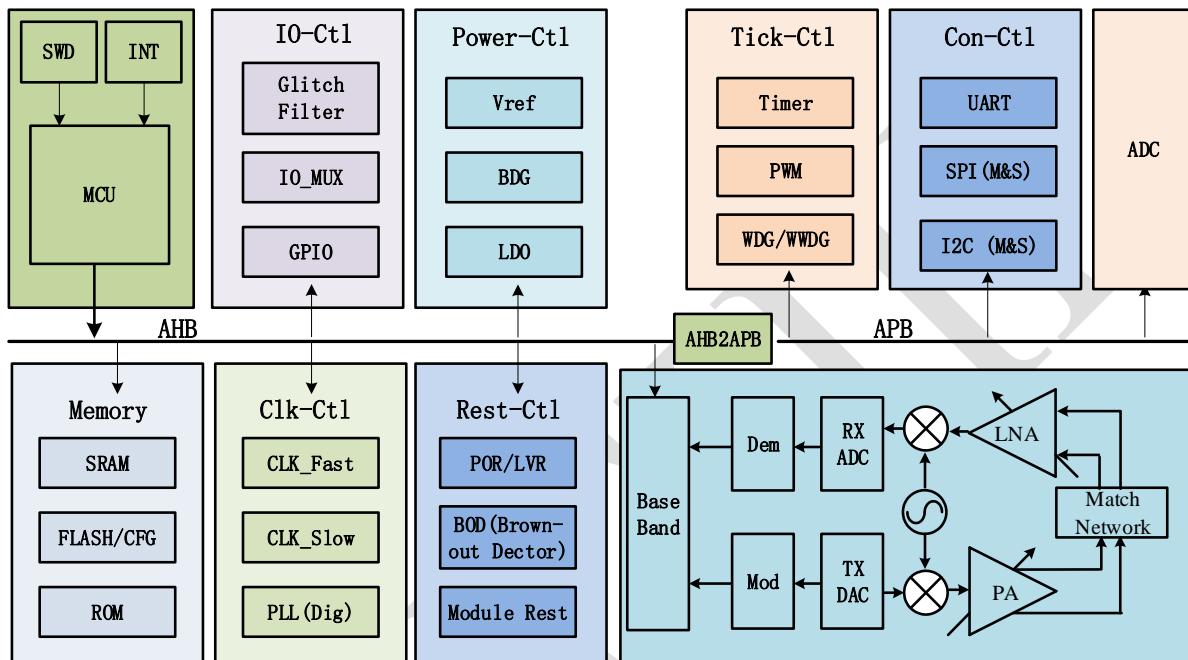


Figure 2-1 PAN1020 Block Diagram

## 3 Pin Information

### 3.1 QFN 32-PIN Diagram

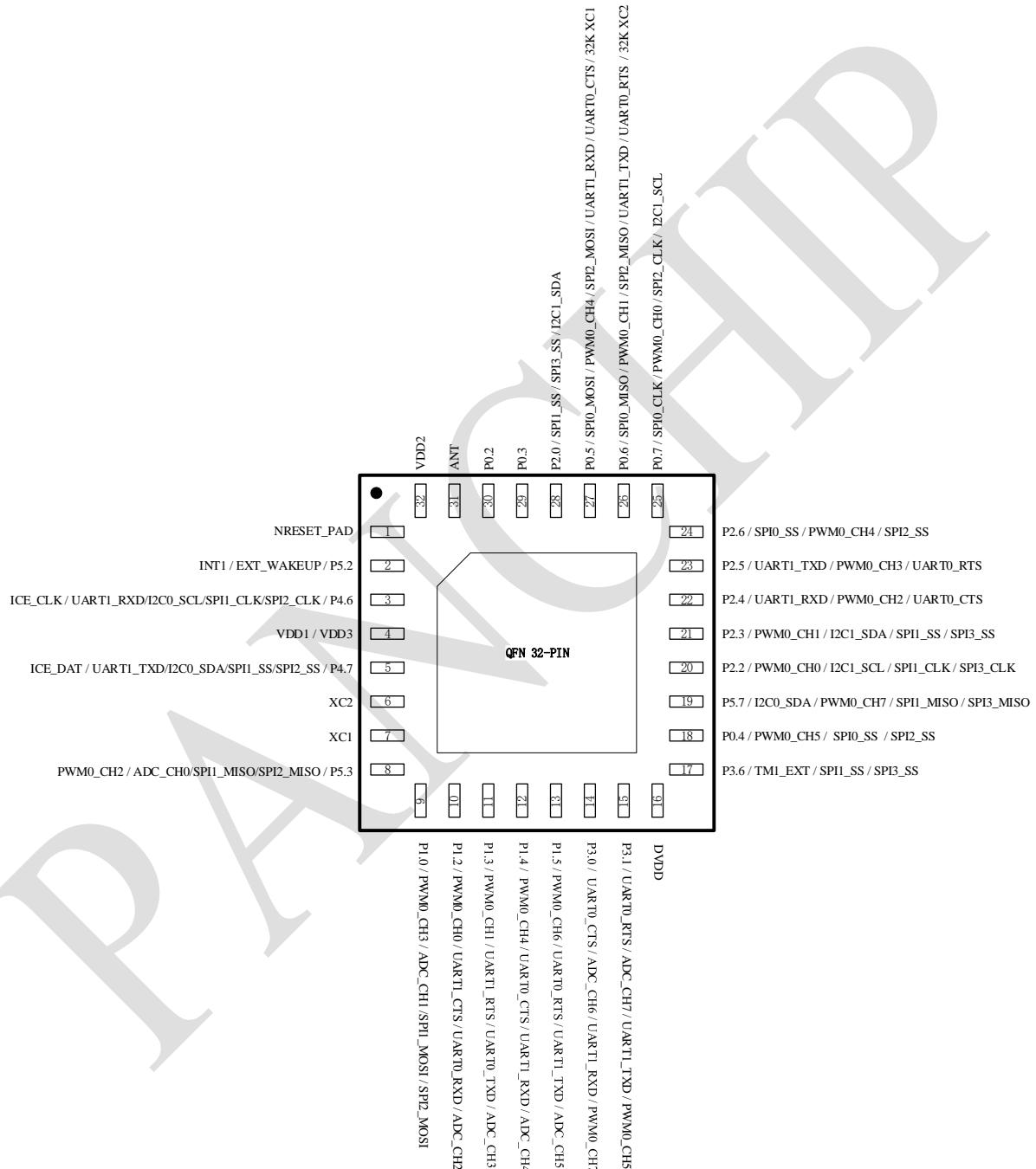


Figure 3-1 PAN1020 QFN 32-PIN Diagram

### 3.2 QFN 48-PIN Diagram

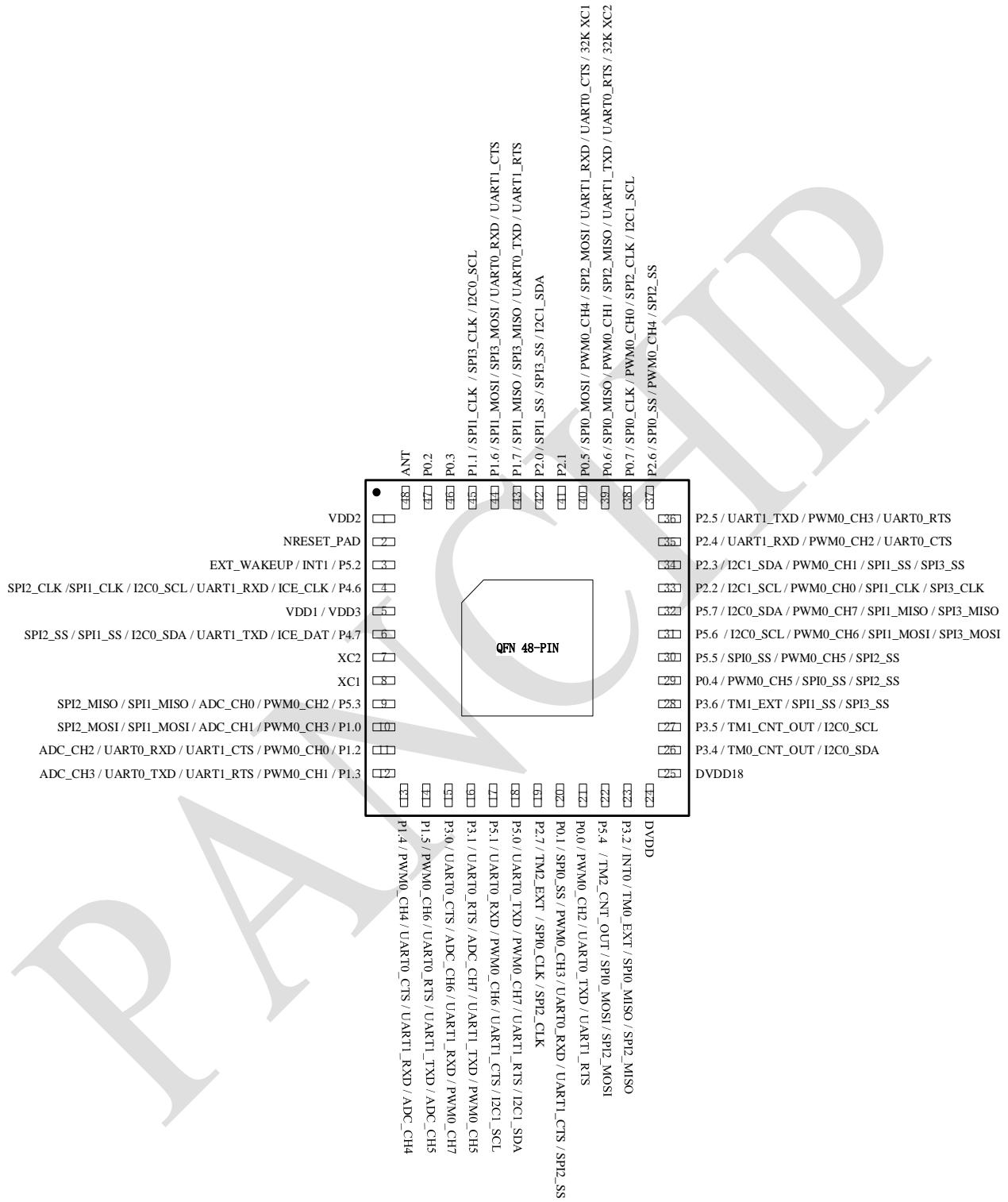


Figure 3-2 PAN1020 QFN 48-PIN Diagram

### 3.3 SSOP24-PIN Diagram

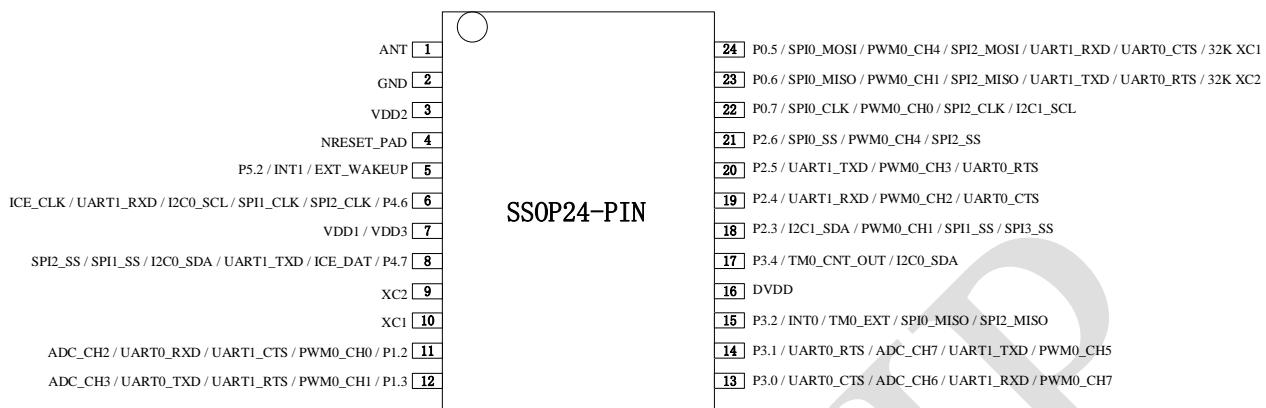


Figure 3-3 PAN1020 SSOP24-PIN Diagram

### 3.4 Pin Descriptions

Detail pin descriptions see Table 3-1.

Table 3-1 PAN1020 Pin descriptions

| Pin Number |        |        | Pin Name   | Pin Type | Description                     |
|------------|--------|--------|------------|----------|---------------------------------|
| QFN 32     | QFN 48 | SSOP24 |            |          |                                 |
| 1          | 2      | 4      | NRESET_PAD | I        | Reset pin                       |
| 2          | 3      | 5      | P5.2       | I/O      | General purpose digital I/O pin |
|            |        |        | INT1       | I        | External interrupt pin          |
|            |        |        | EXT_WAKEUP | I        | External wake-up pin            |
| 3          | 4      | 6      | P4.6       | I/O      | General purpose digital I/O pin |
|            |        |        | ICE_CLK    | I        | ICE clk input pin               |
|            |        |        | UART1_RXD  | I        | UART1 RX pin                    |
|            |        |        | I2C0_SCL   | I/O      | I2C0 CLK pin                    |
|            |        |        | SPI1_CLK   | O        | SPI1 CLK pin                    |
|            |        |        | SPI2_CLK   | I        | SPI2 CLK pin                    |
| 4          | 5      | 7      | VDD1       | P        | SoC power supply VDD1 pin       |
|            |        |        | VDD3       | P        | SoC power supply VDD3 pin       |
| 5          | 6      | 8      | P4.7       | I/O      | General purpose digital I/O pin |
|            |        |        | ICE_DAT    | I        | Debug and program data pin      |
|            |        |        | UART1_TXD  | O        | UART1 TX pin                    |
|            |        |        | I2C0_SDA   | I/O      | I2C0 data pin                   |
|            |        |        | SPI1_SS    | O        | SPI1 SS pin                     |



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|    |    |    |           |     |                                 |
|----|----|----|-----------|-----|---------------------------------|
|    |    |    | SPI2_SS   | I   | SPI2 SS pin                     |
| 6  | 7  | 9  | XC2       | AO  | Crystal pin2                    |
| 7  | 8  | 10 | XC1       | AI  | Crystal pin1                    |
| 8  | 9  | -  | P5.3      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH2  | O   | PWM0 channel2 output pin        |
|    |    |    | ADC_CH0   | AI  | ADC channel0 analog input pin   |
|    |    |    | SPI1_MISO | I   | SPI1 MISO pin                   |
|    |    |    | SPI2_MISO | O   | SPI2 MISO pin                   |
| 9  | 10 | -  | P1.0      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH3  | O   | PWM0 channel3 output pin        |
|    |    |    | ADC_CH1   | AI  | ADC channel1 analog input pin   |
|    |    |    | SPI1_MOSI | O   | SPI1 MOSI pin                   |
|    |    |    | SPI2_MOSI | I   | SPI2 MOSI pin                   |
| 10 | 11 | 11 | P1.2      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH0  | O   | PWM0 channel0 output pin        |
|    |    |    | UART1_CTS | I   | UART1 CTS pin                   |
|    |    |    | UART0_RXD | I   | UART0 RX pin                    |
|    |    |    | ADC_CH2   | AI  | ADC channel2 analog input pin   |
| 11 | 12 | 12 | P1.3      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH1  | O   | PWM0 channel1 output pin        |
|    |    |    | UART1_RTS | O   | UART1 RTS pin                   |
|    |    |    | UART0_TXD | O   | UART0 TX pin                    |
|    |    |    | ADC_CH3   | AI  | ADC channel3 analog input pin   |
| 12 | 13 | -  | P1.4      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH4  | O   | PWM0 channel4 output pin        |
|    |    |    | UART0_CTS | I   | UART0 CTS pin                   |
|    |    |    | UART1_RXD | I   | UART1 RX pin                    |
|    |    |    | ADC_CH4   | AI  | ADC channel4 analog input pin   |
| 13 | 14 | -  | P1.5      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH6  | O   | PWM0 channel6 output pin        |
|    |    |    | UART0_RTS | O   | UART0 RTS pin                   |
|    |    |    | UART1_TXD | O   | UART1 TX pin                    |
|    |    |    | ADC_CH5   | AI  | ADC channel5 analog input pin   |
| 14 | 15 | 13 | P3.0      | I/O | General purpose digital I/O pin |

|    |    |    |           |     |                                 |
|----|----|----|-----------|-----|---------------------------------|
|    |    |    | UART0_CTS | I   | UART0 CTS pin                   |
|    |    |    | ADC_CH6   | AI  | ADC channel6 analog input pin   |
|    |    |    | UART1_RXD | I   | UART1 RX pin                    |
|    |    |    | PWM0_CH7  | O   | PWM0 channel7 output pin        |
| 15 | 16 | 14 | P3.1      | I/O | General purpose digital I/O pin |
|    |    |    | UART0_RTS | O   | UART0 RTS pin                   |
|    |    |    | ADC_CH7   | AI  | ADC channel7 analog input pin   |
|    |    |    | UART1_TXD | O   | UART1 TX pin                    |
|    |    |    | PWM0_CH5  | O   | PWM0 channel5 output pin        |
| -  | 17 | -  | P5.1      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH6  | O   | PWM0 channel output pin         |
|    |    |    | UART0_RXD | I   | UART0 RX pin                    |
|    |    |    | UART1_CTS | I   | UART1 CTS pin                   |
|    |    |    | I2C1_SCL  | I/O | I2C1 CLK pin                    |
| -  | 18 | -  | P5.0      | I/O | General purpose digital I/O pin |
|    |    |    | UART0_TXD | O   | UART0 RX pin                    |
|    |    |    | PWM0_CH7  | O   | PWM0 channel7 output pin        |
|    |    |    | UART1_RTS | O   | UART1 RTS pin                   |
|    |    |    | I2C1_SDA  | I/O | I2C1 data pin                   |
| -  | 19 | -  | P2.7      | I/O | General purpose digital I/O pin |
|    |    |    | TM2_EXT   | I   | Timer2 external input pin       |
|    |    |    | SPI0_CLK  | O   | SPI0 CLK pin                    |
|    |    |    | SPI2_CLK  | I   | SPI2 CLK pin                    |
| -  | 20 | -  | P0.1      | I/O | General purpose digital I/O pin |
|    |    |    | SPI0_SS   | O   | SPI0 SS pin                     |
|    |    |    | PWM0_CH3  | O   | PWM0 channel3 output pin        |
|    |    |    | UART0_RXD | I   | UART0 RX pin                    |
|    |    |    | UART1_CTS | I   | UART1 CTS pin                   |
|    |    |    | SPI2_SS   | I   | SPI2 SS pin                     |
| -  | 21 | -  | P0.0      | I/O | General purpose digital I/O pin |
|    |    |    | PWM0_CH2  | O   | PWM0 channel2 output pin        |
|    |    |    | UART0_TXD | O   | UART0 TX pin                    |
|    |    |    | UART1_RTS | O   | UART1 RTS pin                   |
| -  | 22 | -  | P5.4      | I/O | General purpose digital I/O pin |

|    |    |    |             |     |  |
|----|----|----|-------------|-----|--|
|    |    |    | TM2_CNT_OUT | O   | TM2_CNT output pin                           |
|    |    |    | SPI0_MOSI   | O   | SPI0 MOSI pin                                |
|    |    |    | SPI2_MOSI   | I   | SPI2 MOSI pin                                |
| -  | 23 | 15 | P3.2        | I/O | General purpose digital I/O pin              |
|    |    |    | INT0        | I/O | External interrupt0                          |
|    |    |    | TM0_EXT     | I   | Timer0 external input pin                    |
|    |    |    | SPI0_MISO   | I   | SPI0 MISO pin                                |
|    |    |    | SPI2_MISO   | O   | SPI2 MISO pin                                |
| 16 | 24 | 16 | DVDD        | P   | Core power supply, generated by internal LDO |
| -  | 25 | -  | DVDD18      | P   | -  |
| -  | 26 | 17 | P3.4        | I/O | General purpose digital I/O pin              |
|    |    |    | TM0_CNT_OUT | O   | TM0_CNT output pin                           |
|    |    |    | I2C0_SDA    | I/O | I2C0 data pin                                |
| -  | 27 | -  | P3.5        | I/O | General purpose digital I/O pin              |
|    |    |    | TM1_CNT_OUT | O   | TM1_CNT output pin                           |
|    |    |    | I2C0_SCL    | I/O | I2C0 CLK pin                                 |
| 17 | 28 | -  | P3.6        | I/O | General purpose digital I/O pin              |
|    |    |    | TM1_EXT     | I   | Timer1 external input pin                    |
|    |    |    | SPI1_SS     | O   | SPI1 SS pin                                  |
|    |    |    | SPI3_SS     | I   | SPI3 SS pin                                  |
| 18 | 29 | -  | P0.4        | I/O | General purpose digital I/O pin              |
|    |    |    | PWM0_CH5    | O   | PWM0 channel5 output pin                     |
|    |    |    | SPI0_SS     | O   | SPI0 SS pin                                  |
|    |    |    | SPI2_SS     | I   | SPI2 SS pin                                  |
| -  | 30 | -  | P5.5        | I/O | General purpose digital I/O pin              |
|    |    |    | SPI0_SS     | O   | SPI0 SS pin                                  |
|    |    |    | PWM0_CH5    | O   | PWM0 channel5 output pin                     |
|    |    |    | SPI2_SS     | I   | SPI2 SS pin                                  |
| -  | 31 | -  | P5.6        | I/O | General purpose digital I/O pin              |
|    |    |    | I2C0_SCL    | I/O | I2C0 CLK pin                                 |
|    |    |    | PWM0_CH6    | O   | PWM0 channel6 output pin                     |
|    |    |    | SPI1_MOSI   | O   | SPI1 MOSI pin                                |
|    |    |    | SPI3_MOSI   | I   | SPI3 MOSI pin                                |
| 19 | 32 | -  | P5.7        | I/O | General purpose digital I/O pin              |

|    |    |    |           |     |                                 |
|----|----|----|-----------|-----|---------------------------------|
|    |    |    | I2C0_SDA  | I/O | I2C0 data pin                   |
|    |    |    | PWM0_CH7  | O   | PWM0 channel7 output pin        |
|    |    |    | SPI1_MISO | I   | SPI1 MISO pin                   |
|    |    |    | SPI3_MISO | O   | SPI3 MISO pin                   |
| 20 | 33 | -  | P2.2      | I/O | General purpose digital I/O pin |
|    |    |    | I2C1_SCL  | I/O | I2C1 CLK pin                    |
|    |    |    | PWM0_CH0  | O   | PWM0 channel0 output pin        |
|    |    |    | SPI1_CLK  | O   | SPI1 CLK pin                    |
|    |    |    | SPI3_CLK  | I   | SPI3 CLK pin                    |
| 21 | 34 | 18 | P2.3      | I/O | General purpose digital I/O pin |
|    |    |    | I2C1_SDA  | I/O | I2C1 data pin                   |
|    |    |    | PWM0_CH1  | O   | PWM0 channel1 output pin        |
|    |    |    | SPI1_SS   | O   | SPI1 SS pin                     |
|    |    |    | SPI3_SS   | I   | SPI3 SS pin                     |
| 22 | 35 | 19 | P2.4      | I/O | General purpose digital I/O pin |
|    |    |    | UART1_RXD | I   | UART1 RX pin                    |
|    |    |    | PWM0_CH2  | O   | PWM0 channel2 output pin        |
|    |    |    | UART0_CTS | I   | UART0 CTS pin                   |
| 23 | 36 | 20 | P2.5      | I/O | General purpose digital I/O pin |
|    |    |    | UART1_TXD | O   | UART1 TX pin                    |
|    |    |    | PWM0_CH3  | O   | PWM0 channel3 output pin        |
|    |    |    | UART0_RTS | O   | UART0 RTS pin                   |
| 24 | 37 | 21 | P2.6      | I/O | General purpose digital I/O pin |
|    |    |    | SPI0_SS   | O   | SPI0 SS pin                     |
|    |    |    | PWM0_CH4  | O   | PWM0 channel4 output pin        |
|    |    |    | SPI2_SS   | I   | SPI2 SS pin                     |
| 25 | 38 | 22 | P0.7      | I/O | General purpose digital I/O pin |
|    |    |    | SPI0_CLK  | O   | SPI0 CLK pin                    |
|    |    |    | PWM0_CH0  | O   | PWM0 channel0 output pin        |
|    |    |    | SPI2_CLK  | I   | SPI2 CLK pin                    |
|    |    |    | I2C1_SCL  | I/O | I2C1 CLK pin                    |
| 26 | 39 | 23 | P0.6      | I/O | General purpose digital I/O pin |
|    |    |    | SPI0_MISO | I   | SPI0 MISO pin                   |
|    |    |    | PWM0_CH1  | O   | PWM0 channel1 output pin        |



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|    |    |    |           |     |                                 |
|----|----|----|-----------|-----|---------------------------------|
|    |    |    | SPI2_MISO | O   | SPI2 MISO pin                   |
|    |    |    | UART1_TXD | O   | UART1 TX pin                    |
|    |    |    | UART0_RTS | O   | UART0 RTS pin                   |
|    |    |    | 32K XC2   | AO  | 32K Crystal pin2                |
| 27 | 40 | 24 | P0.5      | I/O | General purpose digital I/O pin |
|    |    |    | SPI0_MOSI | O   | SPI0 MOSI pin                   |
|    |    |    | PWM0_CH4  | O   | PWM0 channel4 output pin        |
|    |    |    | SPI2_MOSI | I   | SPI2 MOSI pin                   |
|    |    |    | UART1_RXD | I   | UART1 RX pin                    |
|    |    |    | UART0_CTS | I   | UART0 CTS pin                   |
|    |    |    | 32K XC1   | AI  | 32K Crystal pin1                |
| -  | 41 | -  | P2.1      | I/O | General purpose digital I/O pin |
| 28 | 42 | -  | P2.0      | I/O | General purpose digital I/O pin |
|    |    |    | SPI1_SS   | O   | SPI1 SS pin                     |
|    |    |    | SPI3_SS   | I   | SPI3 SS pin                     |
|    |    |    | I2C1_SDA  | I/O | I2C1 data pin                   |
| -  | 43 | -  | P1.7      | I/O | General purpose digital I/O pin |
|    |    |    | SPI1_MISO | I   | SPI1 MISO pin                   |
|    |    |    | SPI3_MISO | O   | SPI3 MISO pin                   |
|    |    |    | UART0_TXD | O   | UART0 TX pin                    |
|    |    |    | UART1_RTS | O   | UART1 RTS pin                   |
| -  | 44 | -  | P1.6      | I/O | General purpose digital I/O pin |
|    |    |    | SPI1_MOSI | O   | SPI1 MOSI pin                   |
|    |    |    | SPI3_MOSI | I   | SPI3 MOSI pin                   |
|    |    |    | UART0_RXD | I   | UART0 RX pin                    |
|    |    |    | UART1_CTS | I   | UART1 CTS pin                   |
| -  | 45 | -  | P1.1      | I/O | General purpose digital I/O pin |
|    |    |    | SPI1_CLK  | O   | SPI1 CLK pin                    |
|    |    |    | SPI3_CLK  | I   | SPI3 CLK pin                    |
|    |    |    | I2C0_SCL  | I/O | I2C0 CLK pin                    |
| 29 | 46 | -  | P0.3      | I/O | General purpose digital I/O pin |



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## PAN1020 BLE SoC Transceiver

|    |    |   |      |     |                                 |
|----|----|---|------|-----|---------------------------------|
| 30 | 47 | - | P0.2 | I/O | General purpose digital I/O pin |
| 31 | 48 | 1 | ANT  | AIO | Antenna pin                     |
| 32 | 1  | 3 | VDD2 | P   | RF power supply VDD2 pin        |
| 33 | 49 | 2 | GND  | P   | Ground pin                      |

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## 4 Electrical Characteristics

All the parameters are accurate to the one decimal place.

### 4.1 Absolute Maximum Ratings

Table 4-1 Absolute maximum ratings

| Symbol           | Description           | Parameter |     |     | Unit |
|------------------|-----------------------|-----------|-----|-----|------|
|                  |                       | Min       | Typ | Max |      |
| VDD              | VDD1/VDD2             | -0.3      | -   | 3.6 | V    |
| V <sub>I</sub>   | Input voltage         | -0.3      | -   | VDD | V    |
| V <sub>O</sub>   | Output voltage        | VSS       | -   | VDD | V    |
| T <sub>OP</sub>  | Operating Temperature | -40       | -   | 125 | °C   |
| T <sub>STG</sub> | Storage Temperature   | -40       | -   | 125 | °C   |

Note: Exceeding one or more of the limiting values may cause permanent damage to PAN1020.

Caution: Electrostatic sensitive device, comply with protection rules when operating.

### 4.2 DC Electrical Characteristics

Table 4-2 Voltage and current

| Symbol                  | Parameter                    | Min     | Typ | Max     | Unit | Test Conditions  |
|-------------------------|------------------------------|---------|-----|---------|------|--|
| VDD1/VDD2               | Power Supply                 | 2.2     | 3   | 3.6     | V    | TA=25°C  |
| VSS                     | Ground                       | -       | 0   | -       | V    | -  |
| I <sub>DP_SLP_PAD</sub> | Deep sleep current           | 1.5     | 2   | 2.5     | uA   | MCU power down, SRAM maintain, HCLK and 32K RC off, wake up by GPIO or RESET |
| I <sub>DP_SLP_RC</sub>  | Deep sleep current           | 2       | 3   | 5       | uA   | MCU power down, SRAM maintain, HCLK off, 32K RC on                           |
| I <sub>TX,0dBm</sub>    | Operating Current of TX mode | -       | 17  | -       | mA   | 0dBm output power  |
| I <sub>TX,8dBm</sub>    | Operating Current of TX mode | -       | 31  | -       | mA   | 8dBm output power  |
| I <sub>TX,10dBm</sub>   | Operating Current of TX mode | -       | 41  | -       | mA   | 10dBm output power   |
| I <sub>RX</sub>         | Operating Current of RX mode | -       | 16  | -       | mA   | Maximum LNA Gain   |
| V <sub>OH</sub>         | Output high level voltage    | VDD-0.3 | -   | VDD     | V    | -  |
| V <sub>OL</sub>         | Output low level voltage     | VSS     | -   | VSS+0.3 | V    | -  |
| V <sub>IH</sub>         | Input high level voltage     | 2.0     | 3   | 3.6     | V    | -  |
| V <sub>IL</sub>         | Input low level voltage      | VSS     | -   | VSS+0.3 | V    | -  |

### 4.3 16 MHz Crystal Oscillator Characteristics

Table 4-3 16M RC oscillator

| Symbol                      | Parameter                    | Conditions  | Min | Typ | Max  | Unit   |
|-----------------------------|------------------------------|---|-----|-----|------|--------|
| F <sub>XTAL(16M)</sub>      | Crystal oscillator frequency | -   | -   | 16  | -    | MHz    |
| ESR(16M)                    | Equivalent series resistance | -   | -   | -   | 80   | Ω      |
| Δf <sub>XTAL(16M)</sub>     | Crystal frequency tolerance  | -   | -20 | -   | 20   | ppm    |
| V <sub>CLK(EXT)(16M)</sub>  | External clock voltage       | -   | 0.1 | 0.8 | -    | V      |
| φN <sub>(EXTERNAL)16M</sub> | Phase noise                  | f <sub>C</sub> = 50 kHz<br>in case of an external reference clock | -   | -   | -130 | dBc/Hz |

### 4.4 32 KHz Crystal Oscillator Characteristics

Table 4-4 32K RC oscillator

| Symbol                     | Parameter                                     | Conditions   | Min  | Typ    | Max | Unit |
|----------------------------|---|--|------|--------|-----|------|
| V <sub>CLK(EXT)(32K)</sub> | External clock voltage                        | peak-peak voltage of external clock at XTAL32Kp, pin XTAL32Km floating.<br>note: XTAL32Kp is internally AC coupled | 0.1  | 0.2    | 1.5 | V    |
| f <sub>XTAL(32k)</sub>     | Crystal oscillator frequency                  | frequency range for an external clock (for a crystal, use either 32.000 kHz or 32.768 kHz)                         | TBD  | 32.768 | TBD | KHz  |
| ESR(32k)                   | Equivalent series resistance                  | -  | -    | -      | 100 | KΩ   |
| Δf <sub>XTAL(32k)</sub>    | Crystal frequency tolerance (including aging) | Timing accuracy is dominated by crystal accuracy. A much smaller value is preferred                                | -250 | -      | 250 | ppm  |

### 4.5 Stable Low Frequency RCX Oscillator Characteristics

Table 4-5 Stable Low Frequency RCX Oscillator

| Symbol                | Parameter                      | Conditions      | Min  | Typ | Max | Unit |
|-----------------------|--------------------------------|-----------------|------|-----|-----|------|
| f <sub>RC(RCX)</sub>  | RCX oscillator frequency       | default setting | -    | 32  | -   | Khz  |
| Δf <sub>RC(RCX)</sub> | RCX oscillator frequency drift | -               | -500 | -   | 500 | ppm  |

## 4.6 AC Electrical Characteristics

Table 4-6 RF

| Symbol             | Condition   | Min  | Typ | Max  | Unit     |
|--------------------|---|------|-----|------|----------|
| General frequency  |   |      |     |      |          |
| Fop                | Operating frequency                                     | 2400 | -   | 2483 | MHz      |
| PLL <sub>res</sub> | PLL Programming resolution                              | -    | 1   | -    | MHz      |
| Fxtal              | Crystal frequency                                       | -    | 16  | -    | MHz      |
| DR                 | Data rate   | -    | 1   | -    | Mbps     |
| Transmitter        |   |      |     |      |          |
| PRF                | Output power  | 2    | 8   | 13   | dBm      |
| PRFC               | Output Power Range                                      | -16  | -   | 13   | dBm      |
| PBW                | 20dB Bandwidth for Modulated Carrier at 1Mbps           | 950  | -   | 1100 | MHz      |
| Spur2M             | In-band 2M Spurious Emission                            | -    | -   | -26  | dBm      |
| Spur $\geq$ 3M     | In-band 3M or greater Spurious Emission                 | -    | -   | -36  | dBm      |
| MDR                | Maximum drift rate                                      | -    | -   | 13   | KHz/50us |
| FD                 | Frequency Deviation                                     | 225  | -   | 275  | KHz      |
| Receiver           |   |      |     |      |          |
| RXmax              | Maximum received signal at <0.1% BER                    | -    | 0   | -    | dBm      |
| RXSENS             | Sensitivity (0.1%BER) @1Mbps                            | -    | -90 | -    | dBm      |
| C/ICO              | C/I Co-channel interference                             | -    | 11  | -    | dBc      |
| C/I1M              | Adjacent 1MHz interference                              | -    | -2  | -    | dBc      |
| C/I2M              | Adjacent 2MHz interference                              | -    | -22 | -    | dBc      |
| C/I $\geq$ 3M      | Adjacent $\geq$ 3MHz interference                       | -    | -38 | -    | dBc      |
| C/Iimage           | Image frequency interference                            | -    | -12 | -    | dBc      |
| C/Iimage $\pm$ 1M  | Adjacent (1MHz) interference to in-band image frequency | -    | -35 | -    | dBc      |
| P_IMD              | Intermodulation interference                            | -    | -45 | -    | dBm      |
| P_Blocking         | Out-of-band Blocking interference                       | -30  | -   | -    | dBm      |

Table 4-7 DPLL

| Symbol            | Parameter             | Min | Typ | Max | Unit | Notes |
|-------------------|-----------------------|-----|-----|-----|------|-------|
| VDD2              | Power Supply          | 2.2 | -   | 3.6 | V    | -     |
| T <sub>A</sub>    | Temperature           | -40 | -   | 125 | °C   | -     |
| Fin               | Input Clock frequency | -   | 12  | -   | MHz  | -     |
|                   |                       | -   | 16  | -   | MHz  | -     |
|                   |                       | -   | 24  | -   | MHz  | -     |
| F <sub>DPLL</sub> | Clock frequency       | -   | 52  | -   | MHz  | -     |

Table 4-8 ADC

| Symbol           | Parameter                   | Min                                      | Typ    | Max        | Unit | Notes    |
|------------------|-----------------------------|--|--------|------------|------|----------|
| -                | Resolution                  | -  | 10     | -          | Bit  | -        |
| VDD2             | Power Supply                | 2.5(for VTOP=2.4V)<br>2.2(for VTOP=1.4V) | -      | 3.6        | VDDA | -        |
| I <sub>TOT</sub> | Operation Current           | 880                                      | -      | 1600       | uA   | -        |
| INL              | Integral Nonlinearity Error | -  | -      | ±2         | LSB  | -        |
| PCLK             | System Clock                | -  | -      | 52         | MHz  | -        |
| Fadc             | Clock Frequency             | -  | -      | 26         | MHz  | -        |
| FS               | Sample Rate                 | -  | -      | 1.625      | MHz  | -        |
| Ts               | Sample Time                 | 7  | -      | -          | PCLK | -        |
| Th               | Compare Time                | 25                                       | -      | -          | PCLK | -        |
| TCONV            | Data Output cycle           | 32                                       | 50     | 170        | PCLK | -        |
| N                | S-H counter                 | 1  | 2      | 7          | -    | -        |
| Vin              | Analog input voltage        | 0.4<br>0.4                               | -<br>- | 2.4<br>1.4 | V    | -        |
| C <sub>in</sub>  | Input Capacitance           | -  | 10     | -          | pF   | -        |
| R <sub>in</sub>  | Input resistance            | 14.6                                     | -      | -          | KΩ   | See Note |
| Vref             | ADC reference voltage       | -  | VBG    | -          | V    | -        |
| DATA             | ADC Output                  | 000                                      | -      | FFF        | HEX  | -        |
| SFDR             | Spurious Free Dynamic range | -  | 64     | -          | dB   | -        |

Note:

$$R_{in} = \frac{EXTSMPT<9:0>(1+ADC_CTL<19:16>)}{f_{adc} \times C_{in} \times \ln \frac{V_{in}}{V_{in}-V_{real}}}$$

Table 4-9 LVR

| Symbol           | Parameter         | Min | Typ | Max | Unit | Notes |
|------------------|-------------------|-----|-----|-----|------|-------|
| VDD2             | Power Supply      | 2.2 | 3   | 3.6 | V    | -     |
| V <sub>LVR</sub> | Threshold Voltage | 1.6 | 1.7 | 1.8 | V    | -     |

Table 4-10 BOD

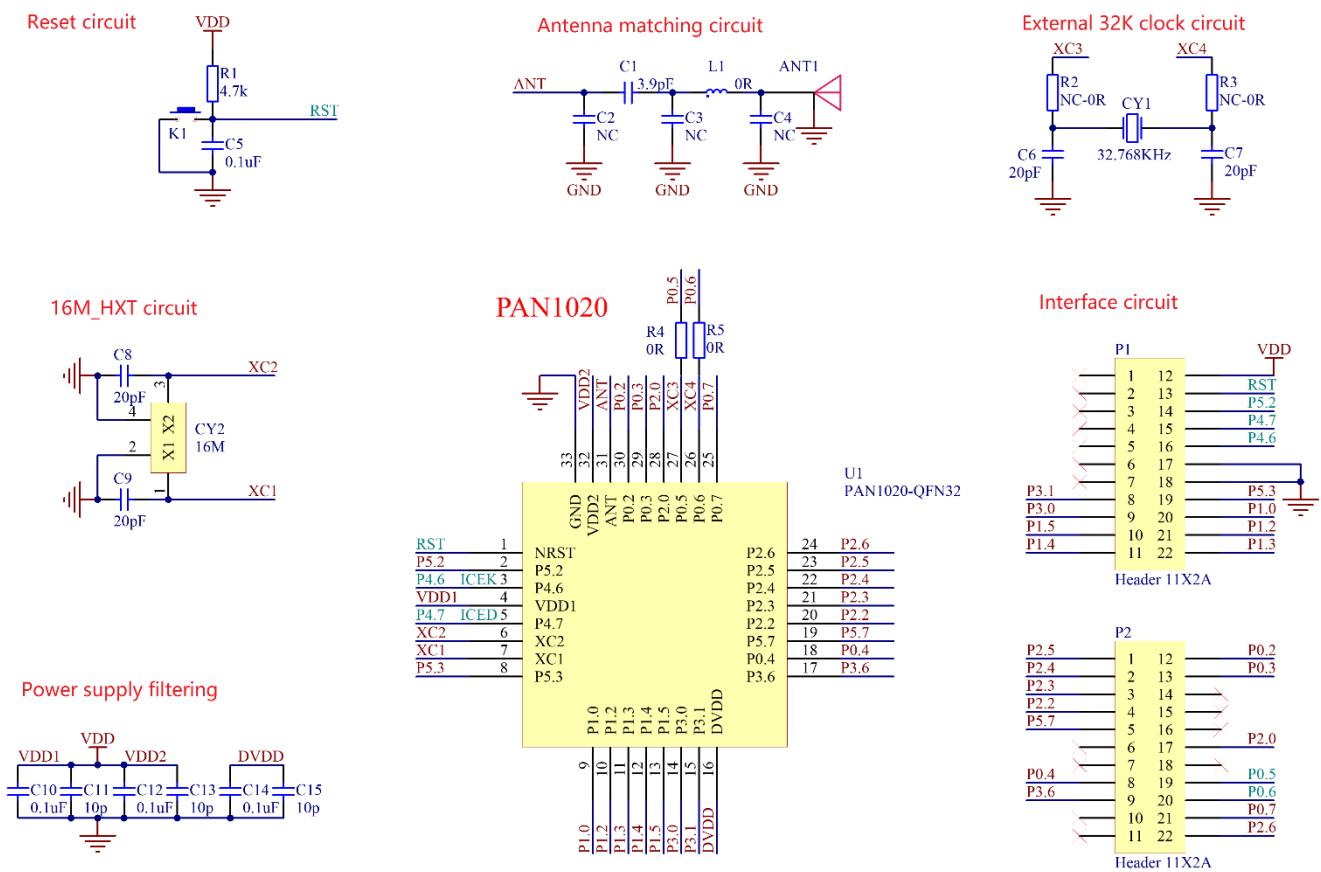
| Symbol           | Parameter          | V <sub>out(V)</sub><br>1→0 | V <sub>out(V)</sub><br>0→1 | Test Conditions          | Notes |
|------------------|--------------------|----------------------------|----------------------------|--------------------------|-------|
| V <sub>BOD</sub> | Brown-Out Detector | 1.93                       | 2.06                       | BODEN=1<br>BODVL<1:0>=00 | -     |
|                  |                    | 2.20                       | 2.34                       | BODEN=1                  | -     |

|  |  |      |      |                          |   |
|--|--|------|------|--------------------------|---|
|  |  |      |      | BODVL<1:0>=01            |   |
|  |  | 2.55 | 2.72 | BODEN=1<br>BODVL<1:0>=10 | - |
|  |  | 2.82 | 2.87 | BODEN=1<br>BODVL<1:0>=11 | - |

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# 5 Application Reference Design

## 5.1 QFN-32 Application Reference Circuit



PAN1020\_QFN32\_Ref\_V1.2

Figure 5-1 Application Reference Circuit for QFN32

## 5.2 QFN-48 Application Reference Circuit

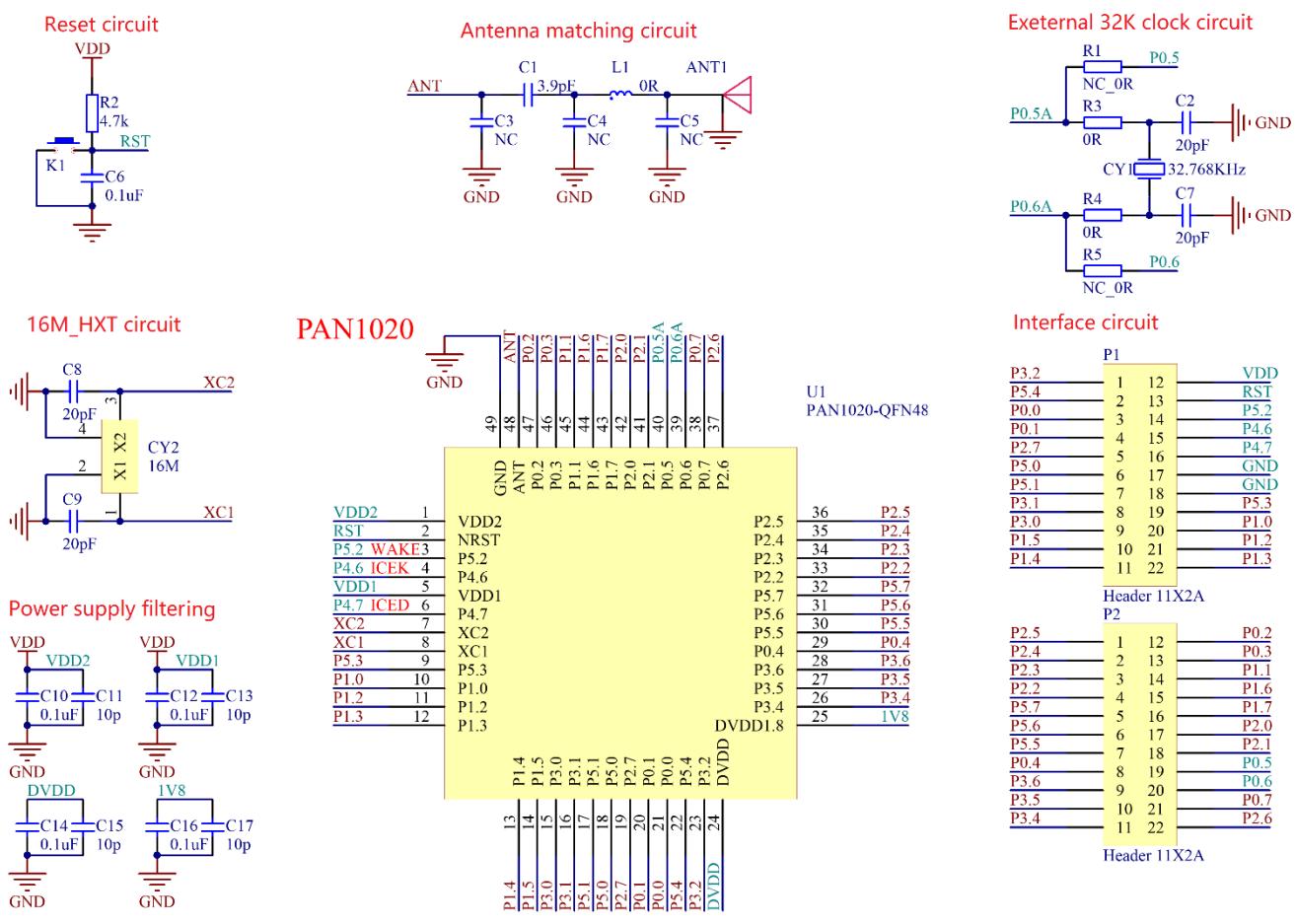


Figure 5-2 Application Reference Circuit for QFN48

### 5.3 SSOP24 Application Reference Circuit

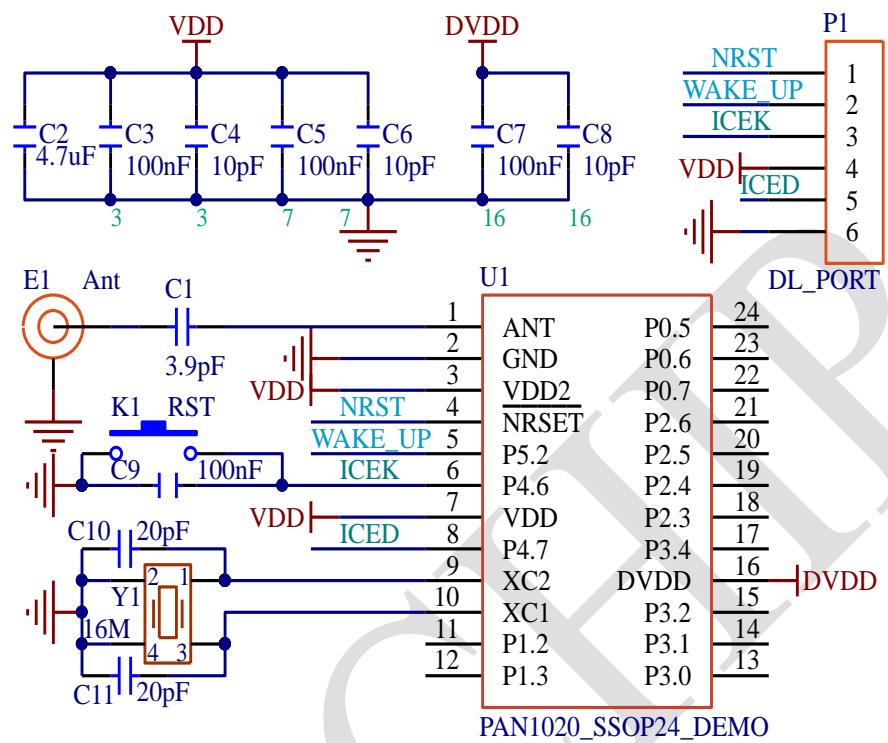


Figure 5-3 Application Reference Circuit for SSOP24

## 6 Pakage Dimensions

### 6.1 QFN-32 Package Dimensions

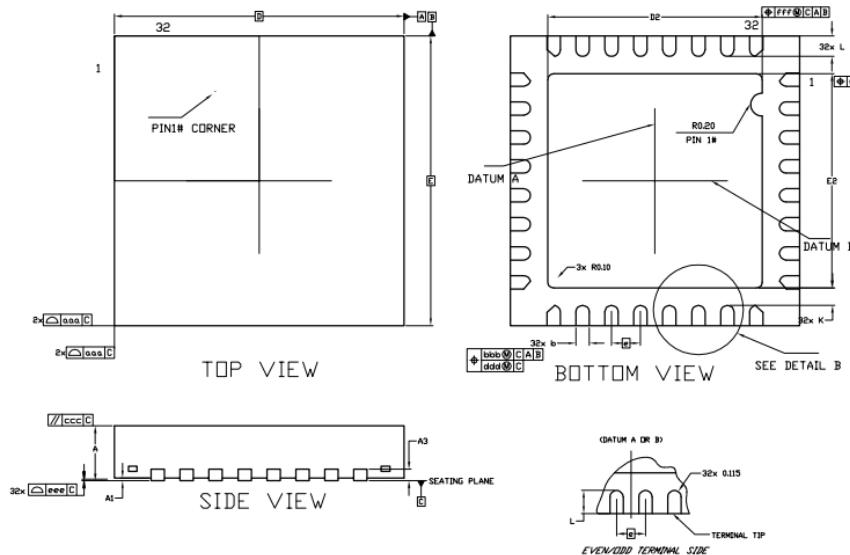


Figure 6-1 QFN32 Package Views

Table 6-1 QFN32 Package Detail Parameters

| DIM SYMBOL | MIN.(mm) | NOM.(mm) | MAX.(mm) |
|------------|----------|----------|----------|
| A          | 0.70     | 0.75     | 0.80     |
|            | 0.85     | 0.90     | 0.95     |
| A1         | 0        | 0.02     | 0.05     |
| A3         | -        | 0.20 REF | -        |
| b          | 0.18     | 0.23     | 0.28     |
| D          |          | 5.00BSC  |          |
| E          |          | 5.00BSC  |          |
| D2         | 3.55     | 3.65     | 3.75     |
| E2         | 3.55     | 3.65     | 3.75     |
| e          |          | 0.50BSC  |          |
| L          | 0.30     | 0.35     | 0.40     |
| K          | 0.20     | -        | -        |
| aaa        |          | 0.15     |          |
| bbb        |          | 0.10     |          |
| ccc        |          | 0.10     |          |
| ddd        |          | 0.05     |          |
| eee        |          | 0.08     |          |
| fff        |          | 0.10     |          |

## 6.2 QFN-48 Package Dimensions

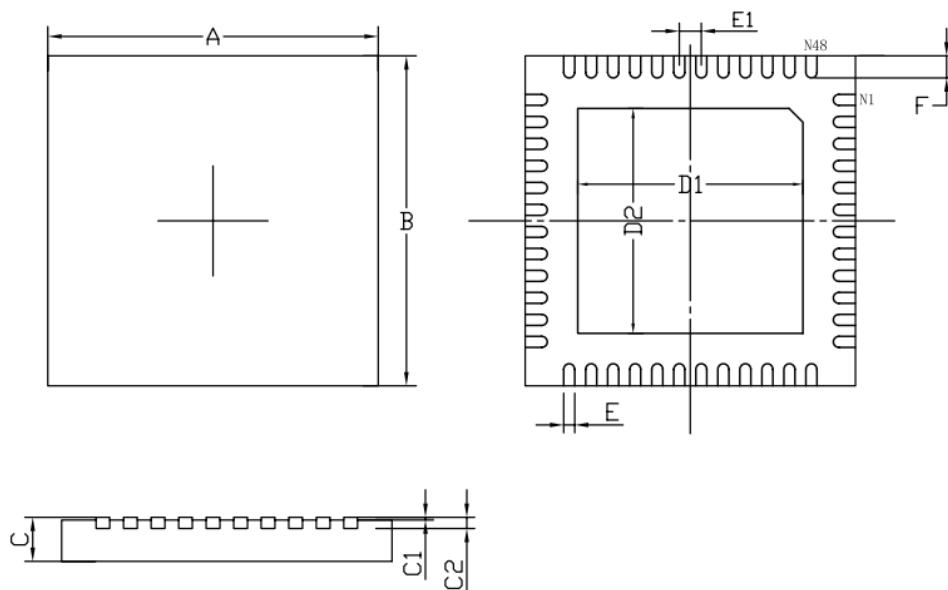


Figure 6-2 QFN48 Package Views

Table 6-2 QFN48 Package Detail Parameters

| <b>DIM SYMBOL</b> | <b>MIN.(mm)</b> | <b>MAX.(mm)</b> |
|-------------------|-----------------|-----------------|
| A                 |                 | $6.0 \pm 0.1$   |
| B                 |                 | $6.0 \pm 0.1$   |
| C                 | 0.70            | 0.80            |
| C1                |                 | 0~0.050         |
| C2                |                 | 0.203TYP        |
| D1                |                 | 4.05TYP         |
| D2                |                 | 4.05TYP         |
| E                 |                 | 0.200TYP        |
| E1                |                 | 0.400TYP        |
| F                 |                 | 0.400TYP        |

### 6.3 SSOP24 Package Dimensions

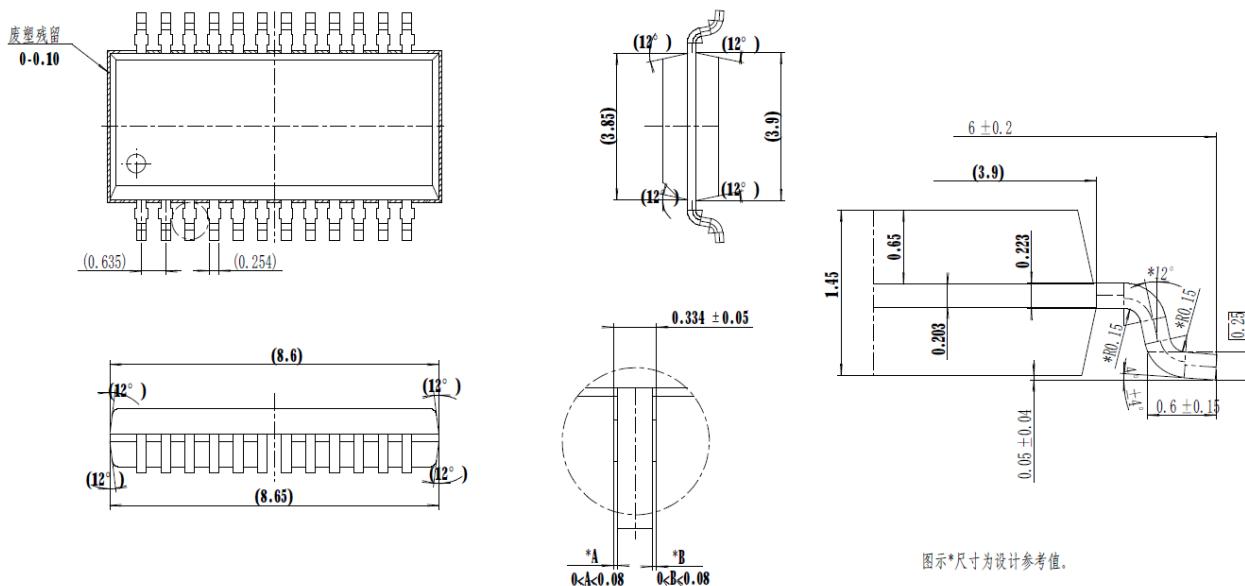


Figure 6-3 SSOP24 Package Views

## 7 Precautions

- 1) This product is a CMOS device and should be protected against static electricity during storage, transportation and use.
- 2) Grounding when device is in use.
- 3) Reflow temperature can not exceed 260°C.

## 8 Storage Conditions

- 1) Products should be stored in sealed packages: when the temperature is less than 30 degrees and the humidity is less than 90%, it can last for 12 months.
- 2) After the package is opened, the components will be used in the reflow process or other high-temperature processes. The following conditions must be met:
  - a) Completed within 72 hours and the factory environment is less than  $30^{\circ}\text{C} \leq 60\% \text{ RH}$ .
  - b) Stored in 10% RH environment.
  - c) Exhaust at  $125^{\circ}\text{C}$  for 24 hours to remove internal water vapor before used.

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